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(12) **United States Design Patent**
Wischnewski

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(45) **Date of Patent:** **** May 9, 2023**

(54) **MIRROR-SYMMETRIC LASER MODULE**

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(**) Term: **15 Years**

(21) Appl. No.: **29/754,468**

(22) Filed: **Oct. 12, 2020**

(30) **Foreign Application Priority Data**

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(51) **LOC (14) Cl.** **15-09**

(52) **U.S. Cl.**
USPC **D15/127; D15/1**

(58) **Field of Classification Search**
USPC **D15/1, 4, 5, 122, 127, 199**

(Continued)

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(Continued)

Primary Examiner — Patricia A Palasik

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(57) **CLAIM**

The ornamental design for a mirror-symmetric laser module, as shown and described.

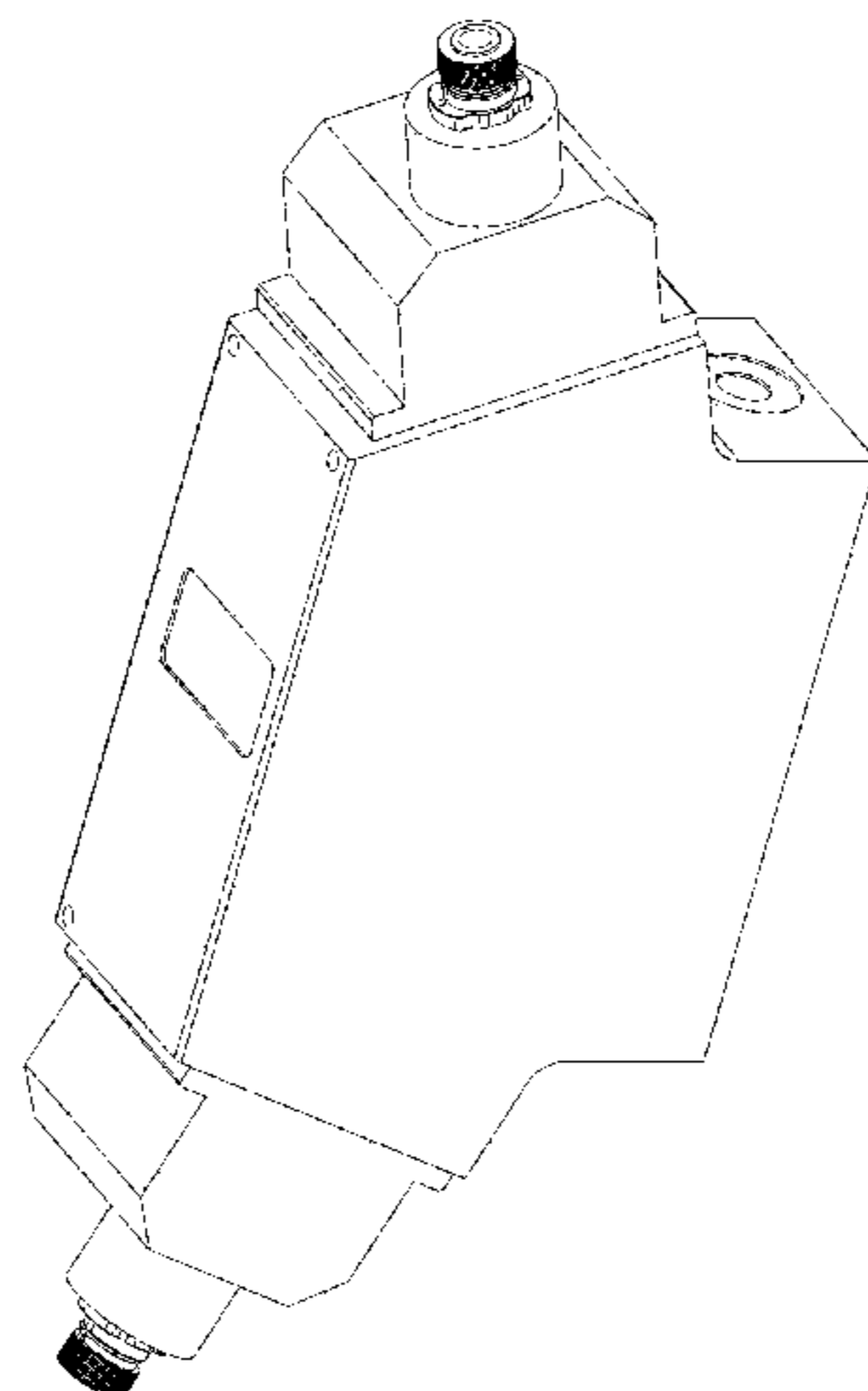
DESCRIPTION

FIG. 1 is a left-top perspective view of my mirror-symmetric laser module according to the first embodiment of my new design;

FIG. 2 is a left-bottom side perspective view thereof;
FIG. 3 is a front elevation view thereof;
FIG. 4 is a rear elevation view thereof;
FIG. 5 is a left side elevation view, the right-side being a mirror image;
FIG. 6 is a top plan view thereof;
FIG. 7 is bottom plan view thereof;
FIG. 8 is a left-top perspective view of my mirror-symmetric laser module according to the second embodiment of my new design;
FIG. 9 is a left-bottom side perspective view thereof;
FIG. 10 is a front elevation view thereof;
FIG. 11 is a rear elevation view thereof;
FIG. 12 is a left side elevation view, the right-side being a mirror image;
FIG. 13 is a top plan view thereof;
FIG. 14 is bottom plan view thereof;
FIG. 15 is a left-top perspective view of my mirror-symmetric laser module according to the third embodiment of my new design;
FIG. 16 is a left-bottom side perspective view thereof;
FIG. 17 is a front elevation view thereof;
FIG. 18 is a rear elevation view thereof;
FIG. 19 is a left side elevation view, the right-side being a mirror image;
FIG. 20 is a top plan view thereof;
FIG. 21 is bottom plan view thereof;
FIG. 22 is a left-top perspective view of my mirror-symmetric laser module according to the fourth embodiment of my new design;
FIG. 23 is a left-bottom side perspective view thereof;
FIG. 24 is a front elevation view thereof;
FIG. 25 is a rear elevation view thereof;
FIG. 26 is a left side elevation view, the right-side being a mirror image;
FIG. 27 is a top plan view thereof; and,
FIG. 28 is bottom plan view thereof.

The broken lines shown in the embodiments set forth in FIGS. 15-28 illustrate portions of the mirror-symmetric laser module that form no part of the claimed design. More particular, the third embodiment shows a pair of the mirror-symmetric laser modules of the first embodiment in a side-by-side orientation and similarly, the fourth embodi-

(Continued)



ment shows a pair of the mirror-symmetric laser modules of the second embodiment in a side-by-side orientation.

1 Claim, 28 Drawing Sheets

(58) Field of Classification Search

CPC H01S 3/036; H01S 3/073; H01S 5/02218;
H01S 5/02315; H01S 5/0233

See application file for complete search history.

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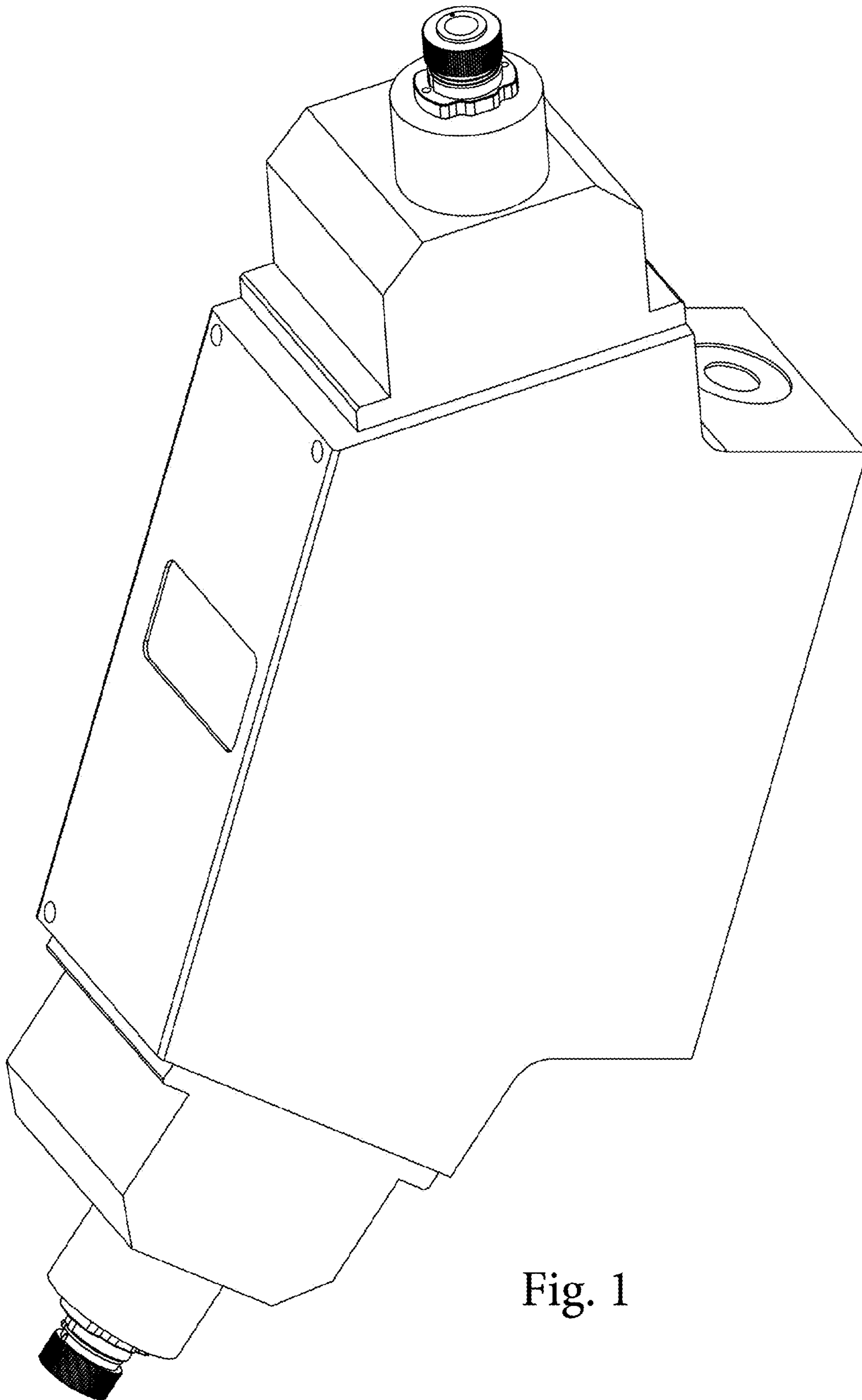


Fig. 1

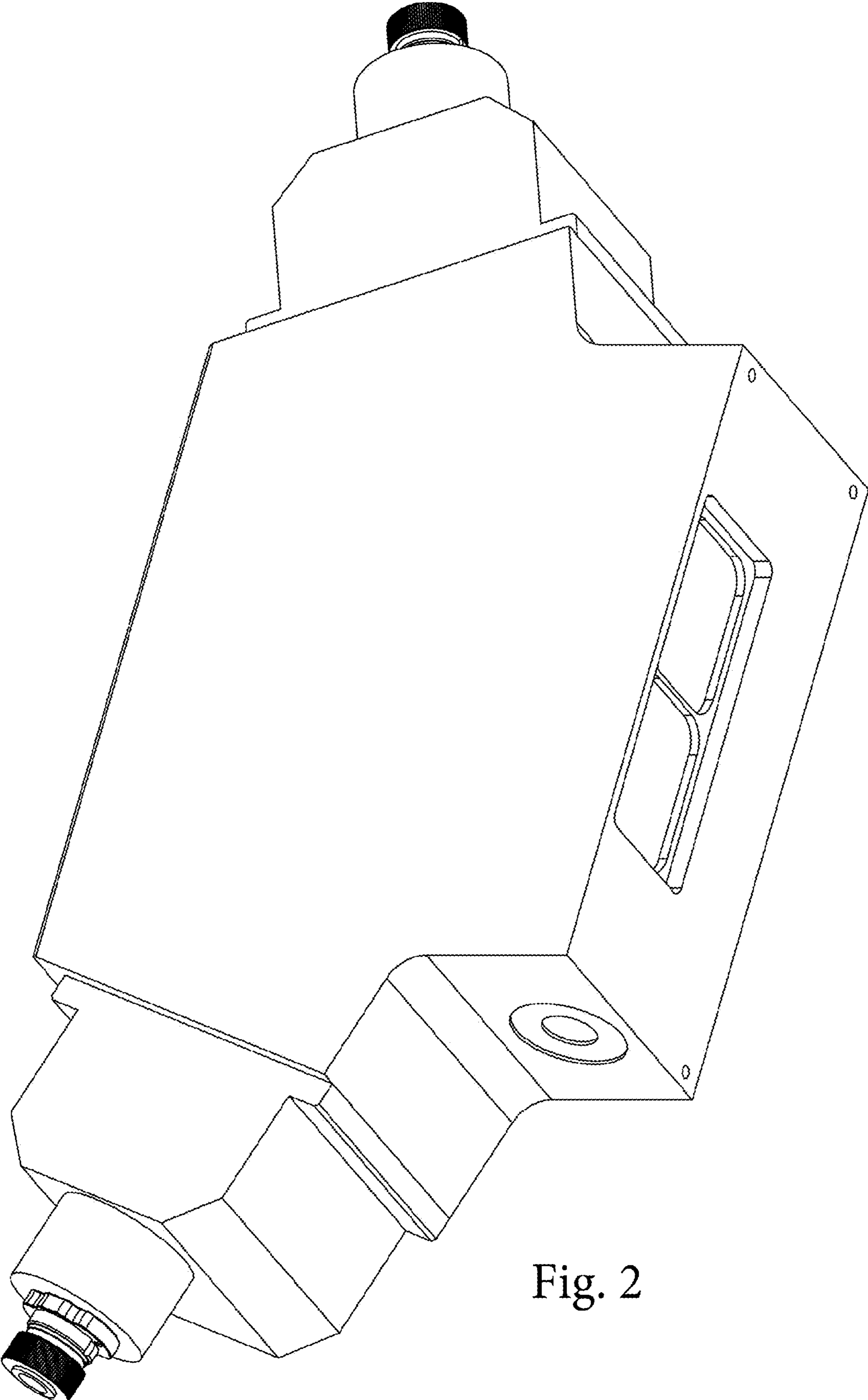


Fig. 2

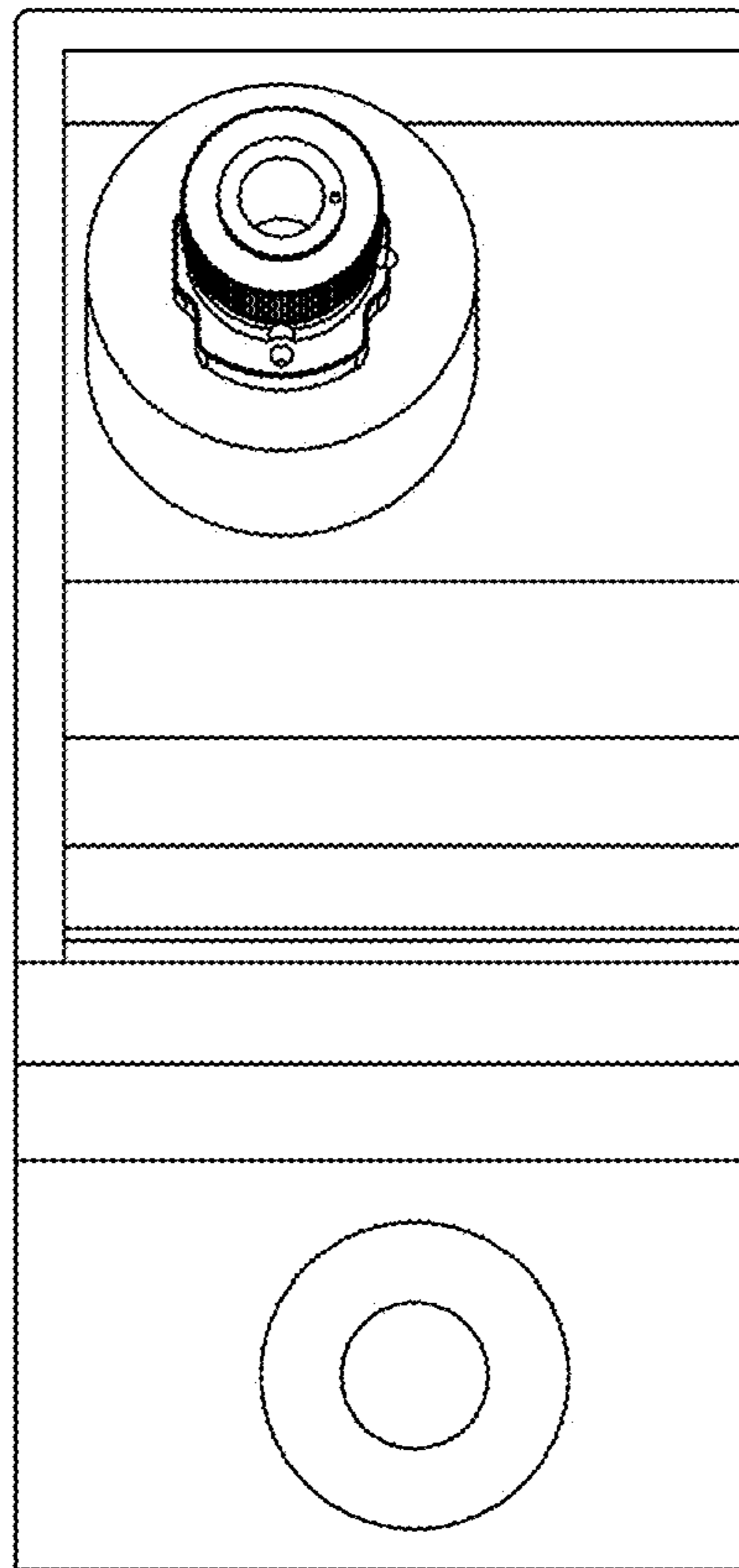


Fig. 3

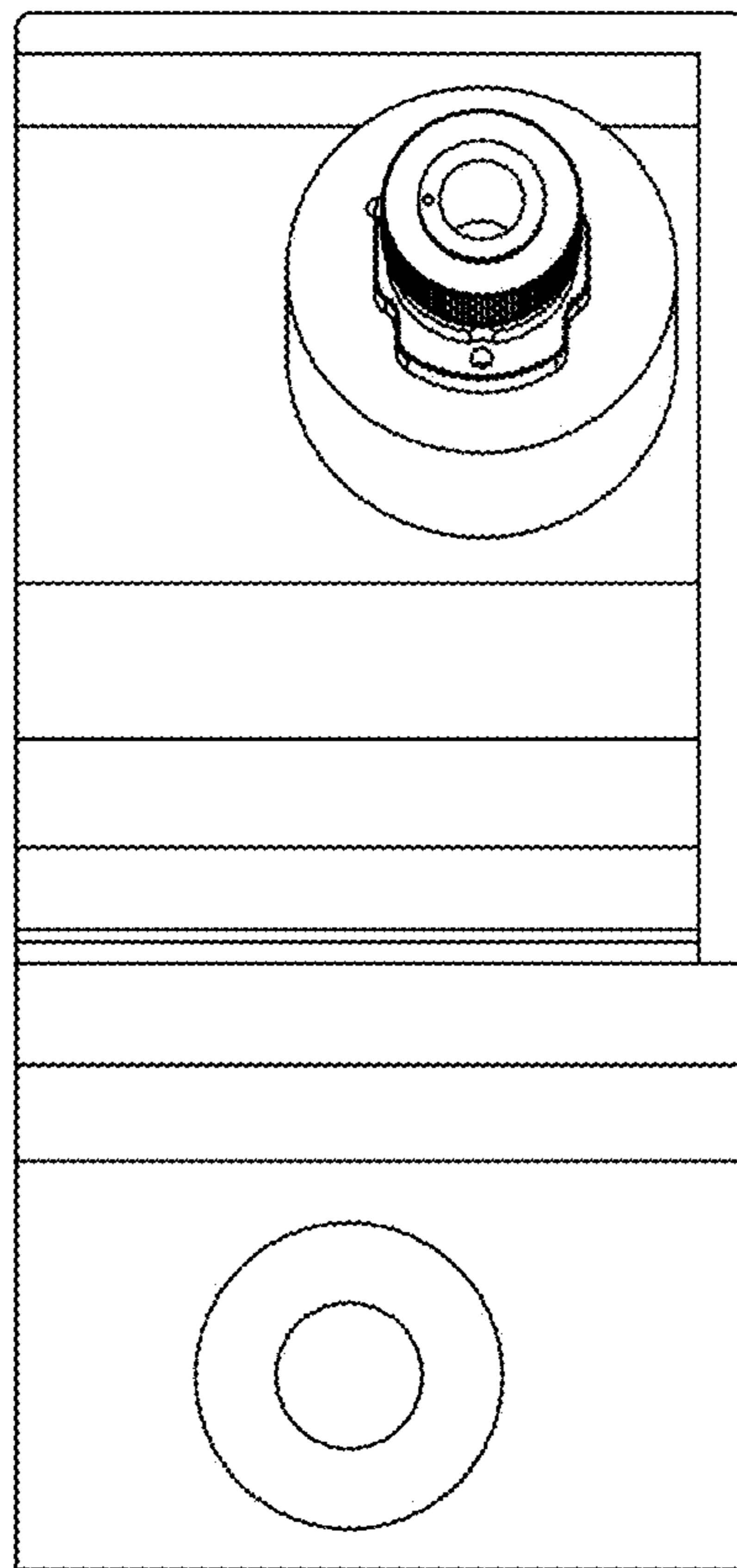


Fig. 4

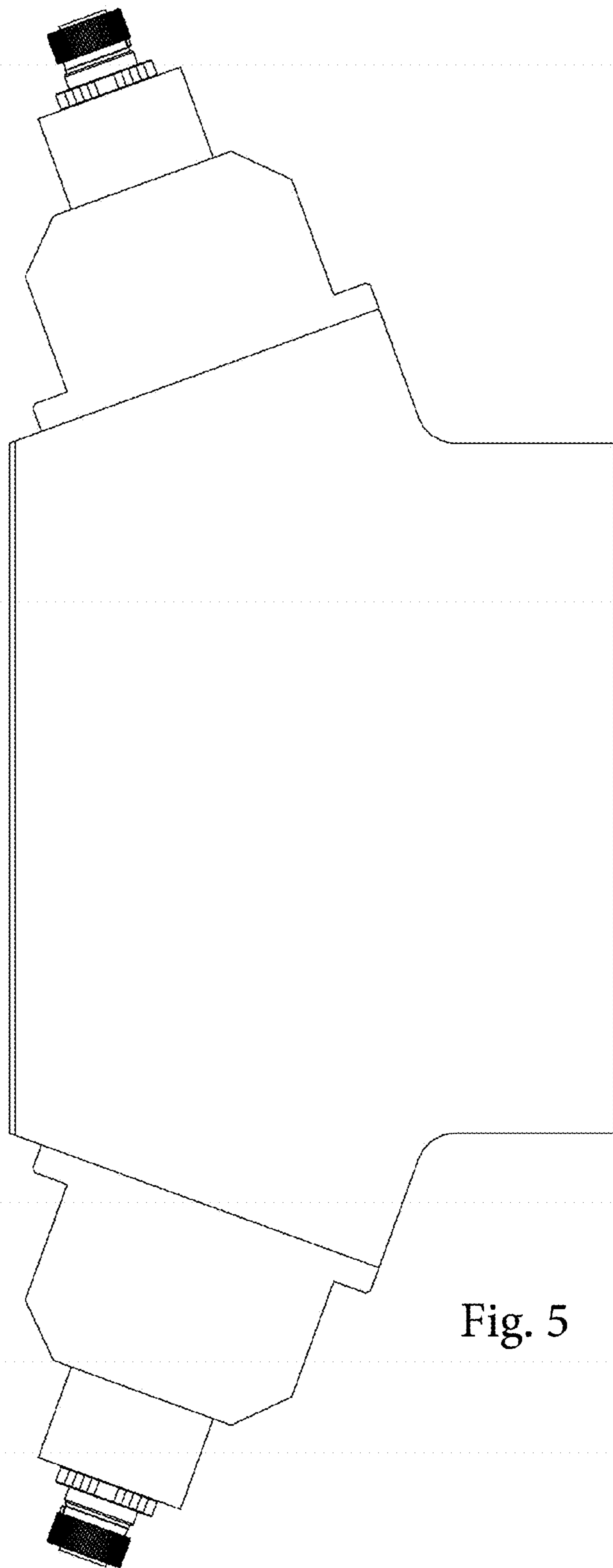


Fig. 5

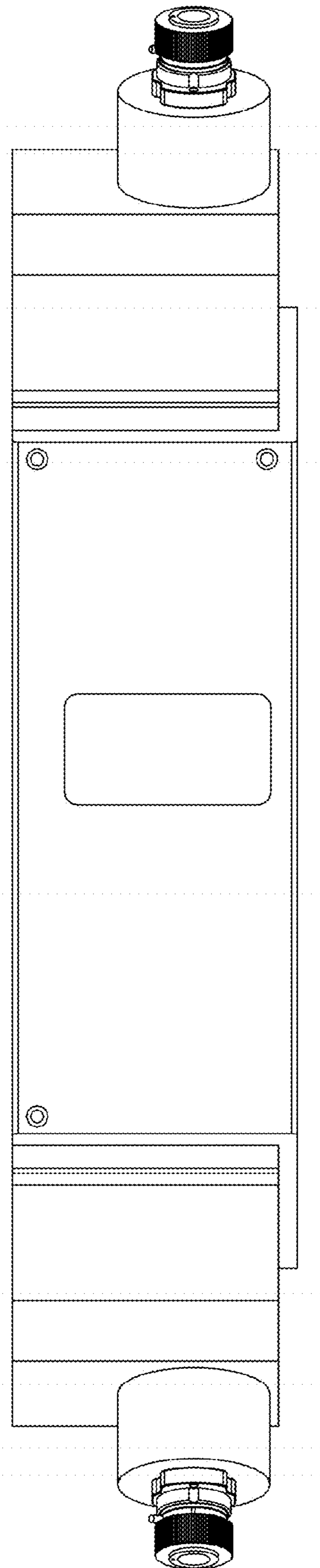


Fig. 6

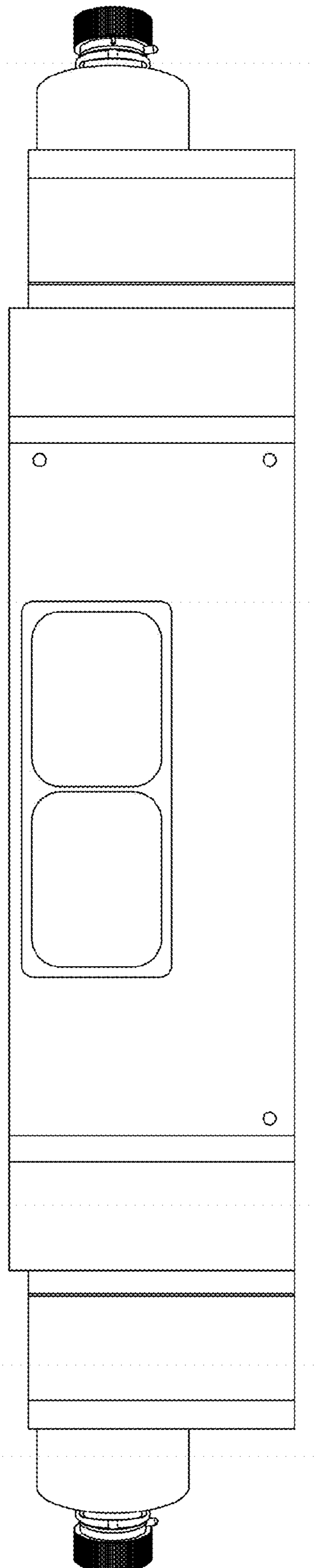


Fig. 7

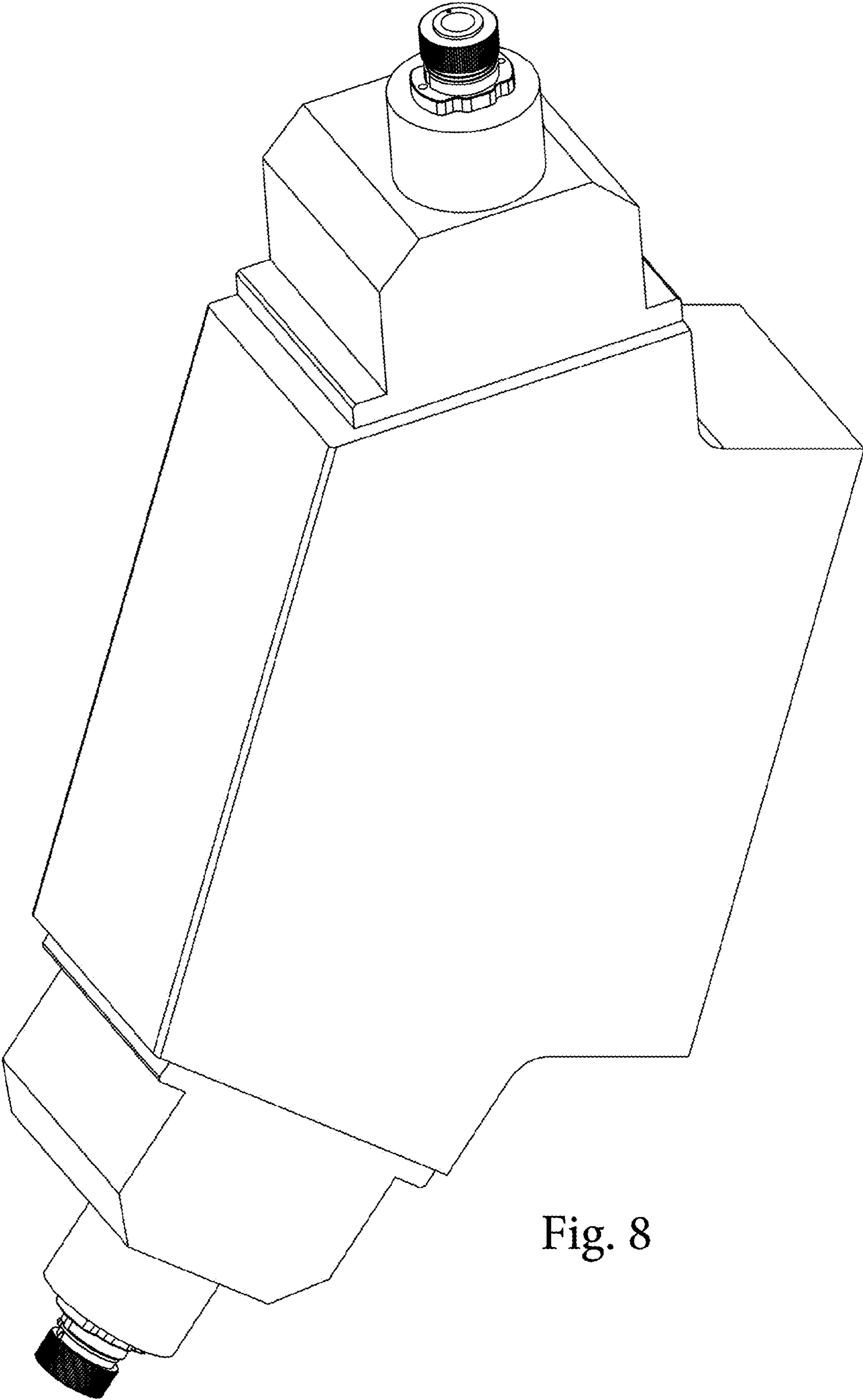


Fig. 8

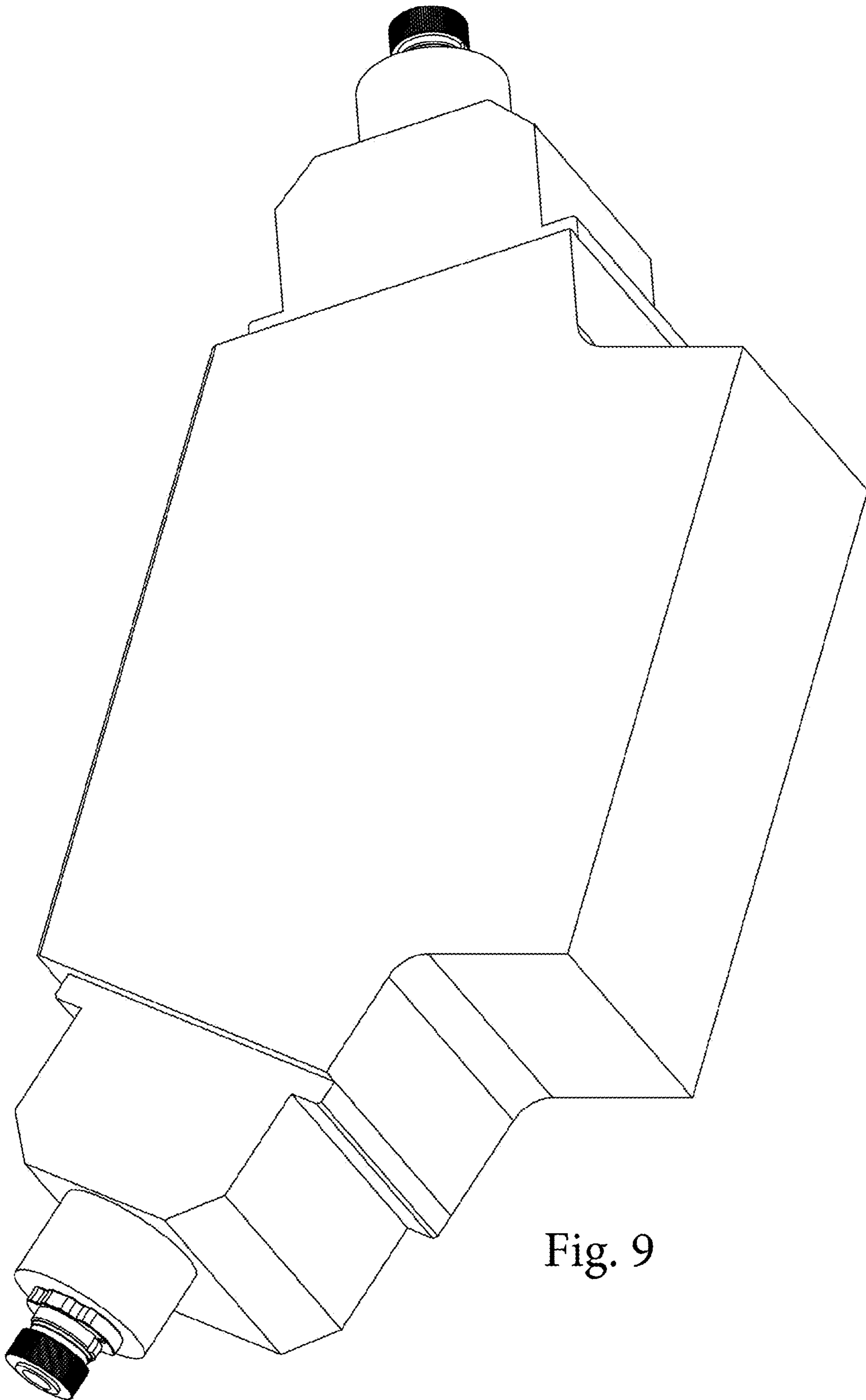


Fig. 9

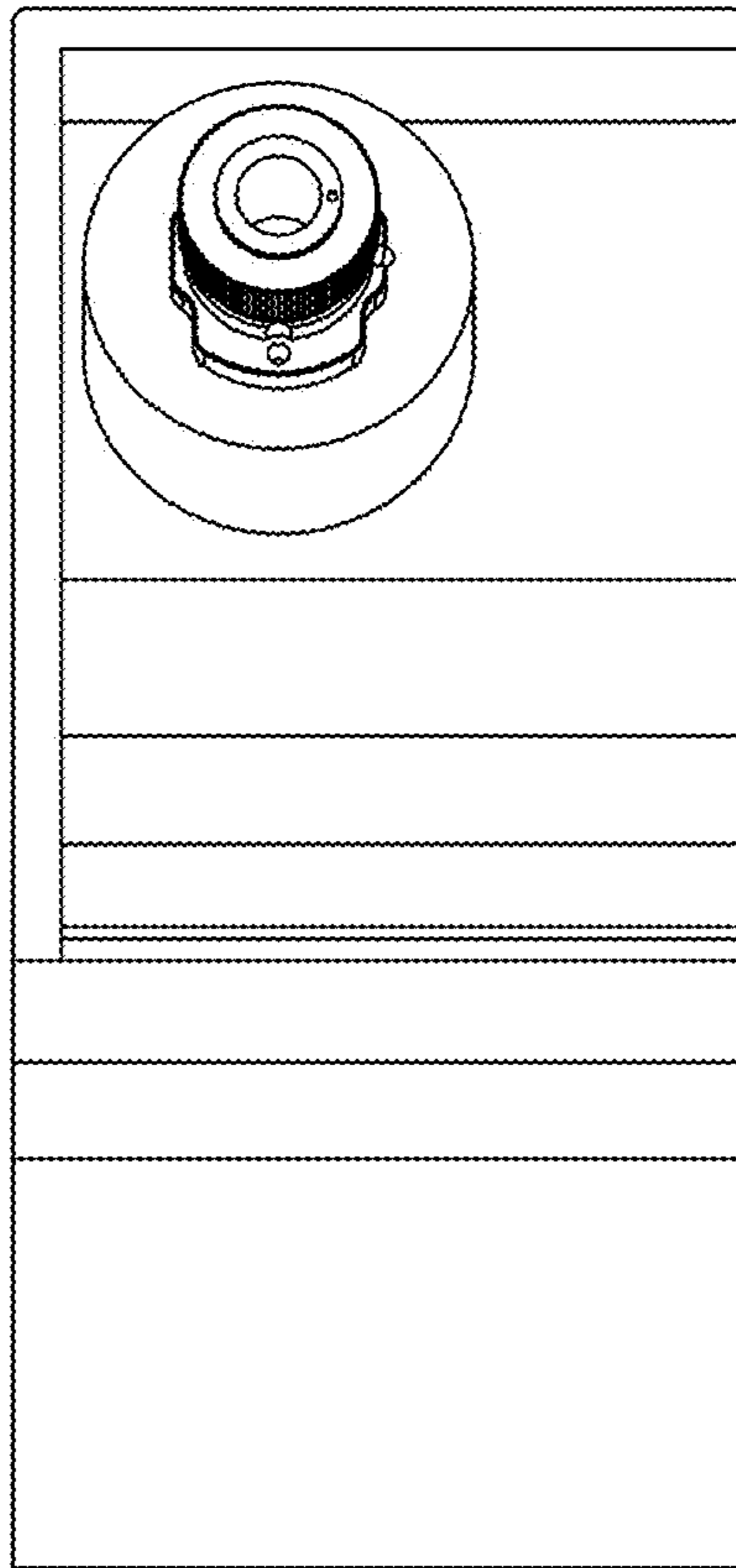


Fig. 10

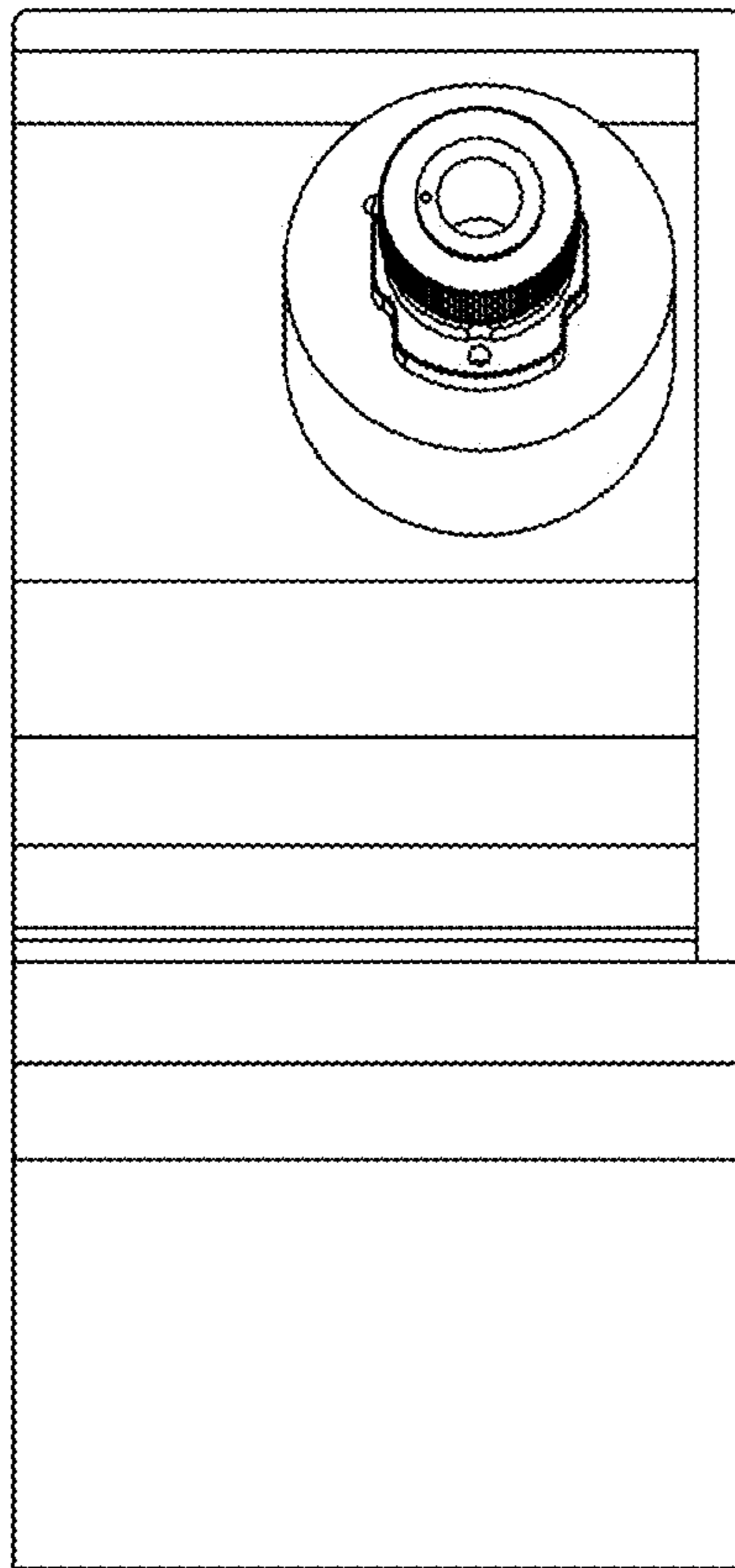


Fig. 11

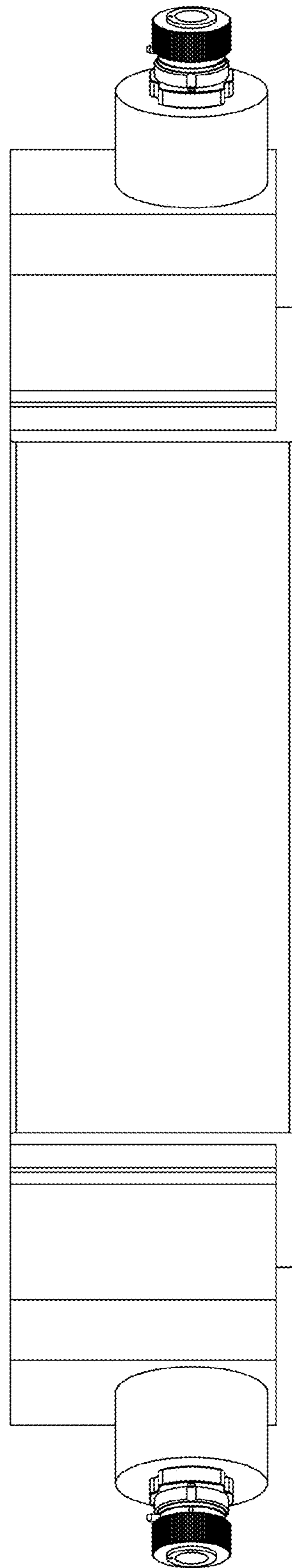


Fig. 12

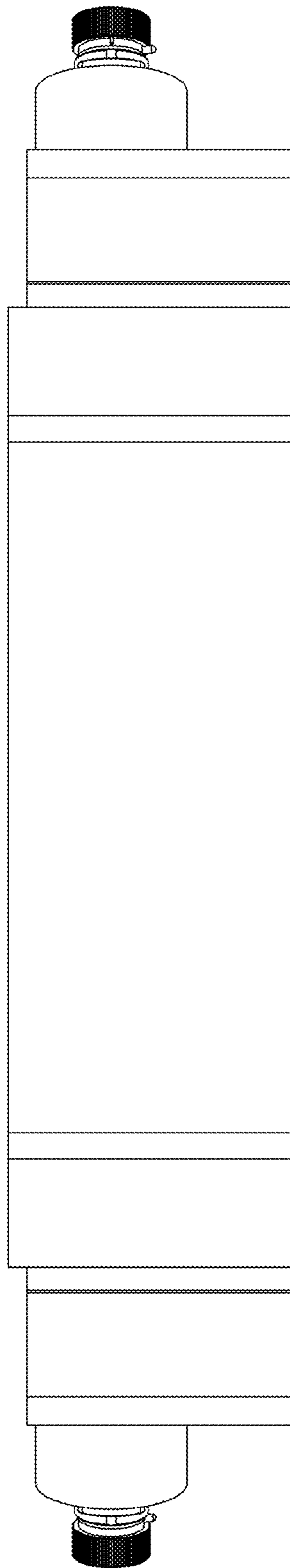


Fig. 13

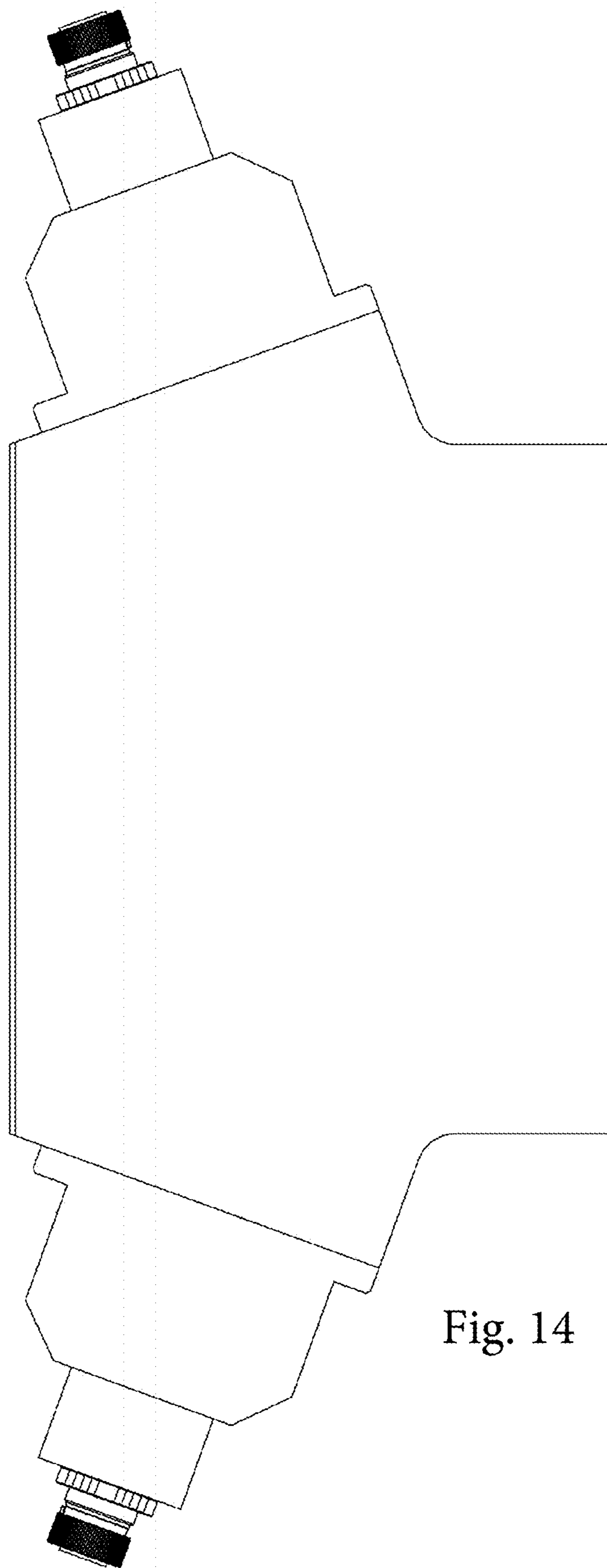


Fig. 14

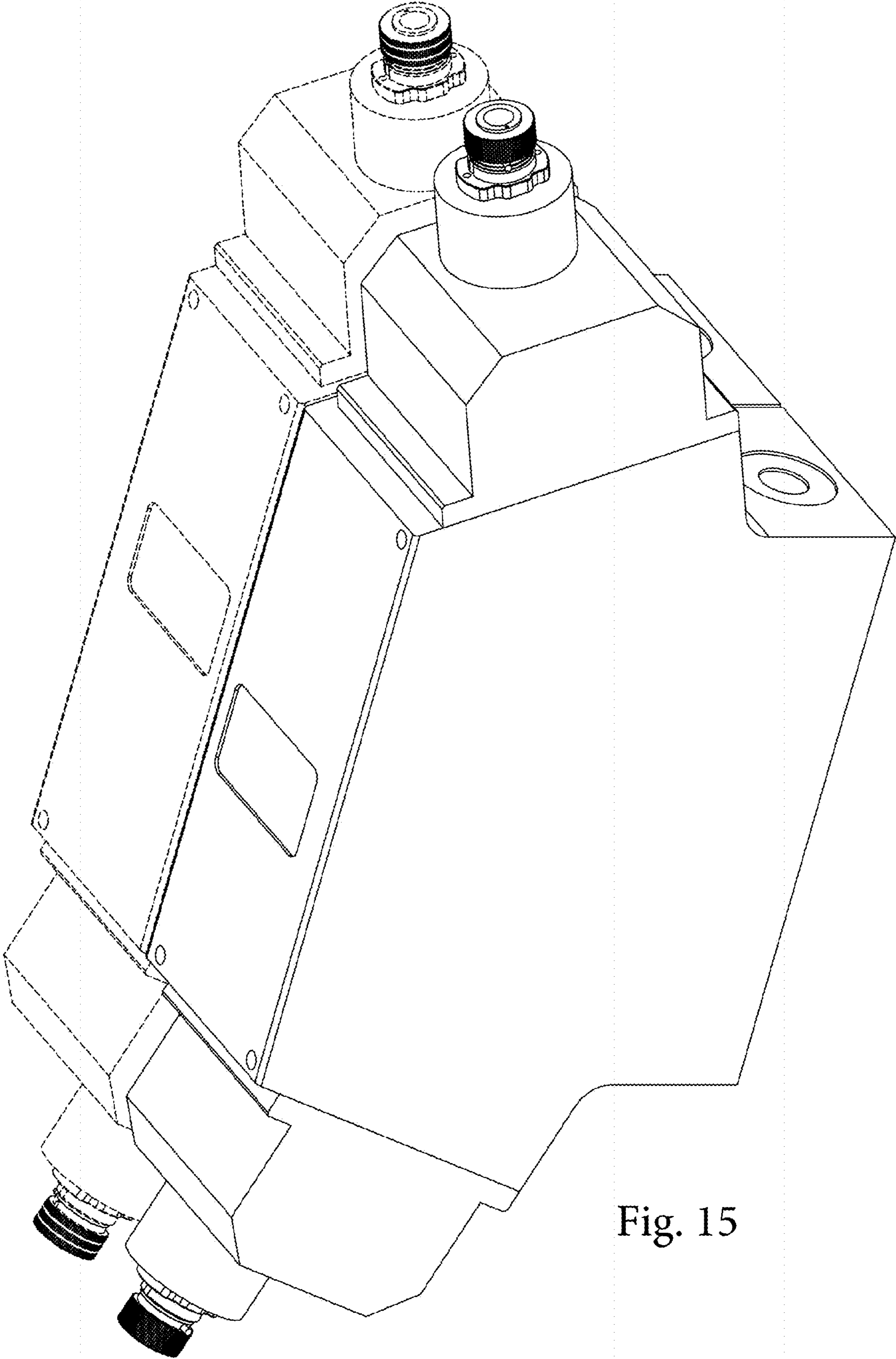


Fig. 15

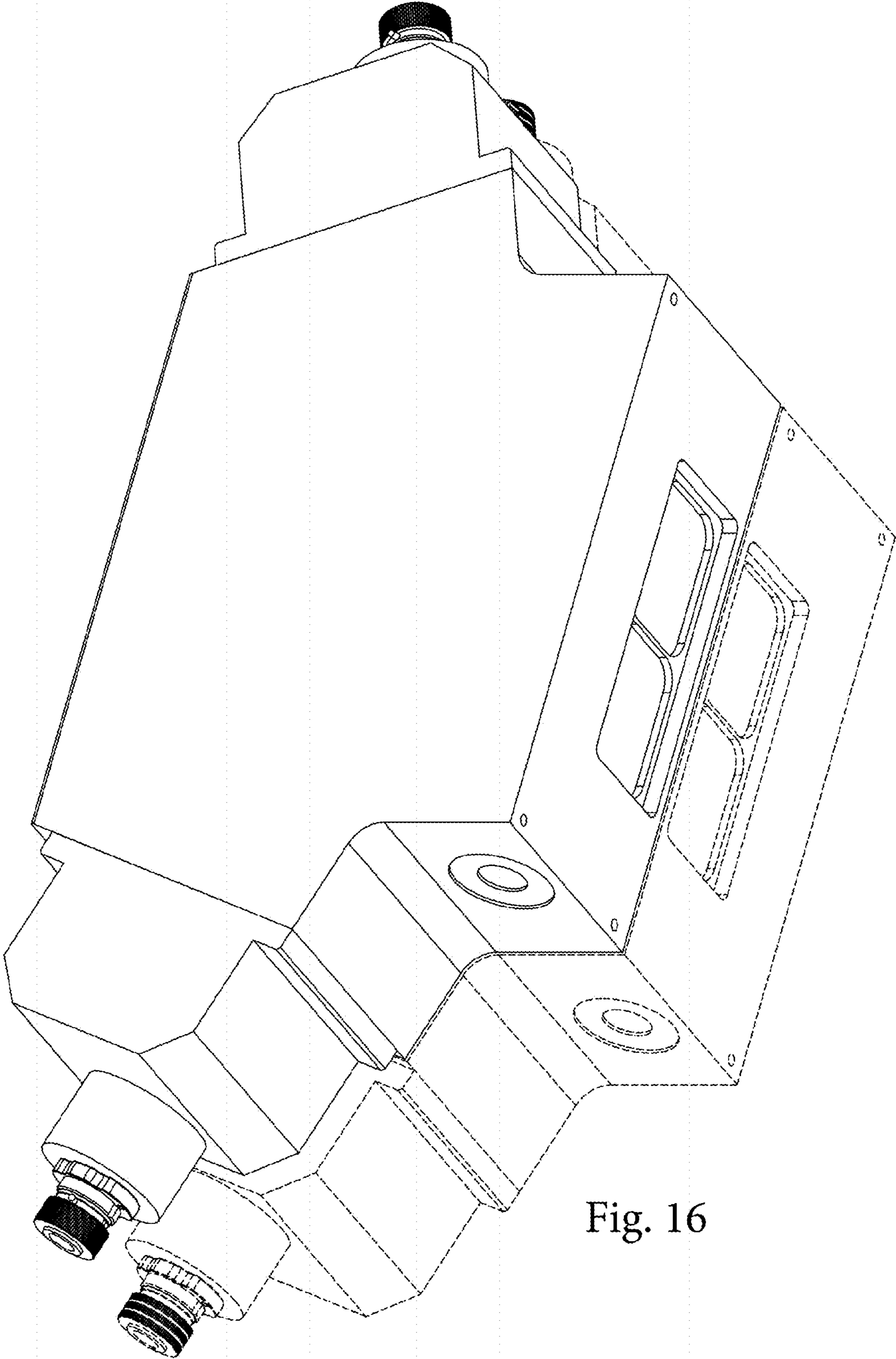


Fig. 16

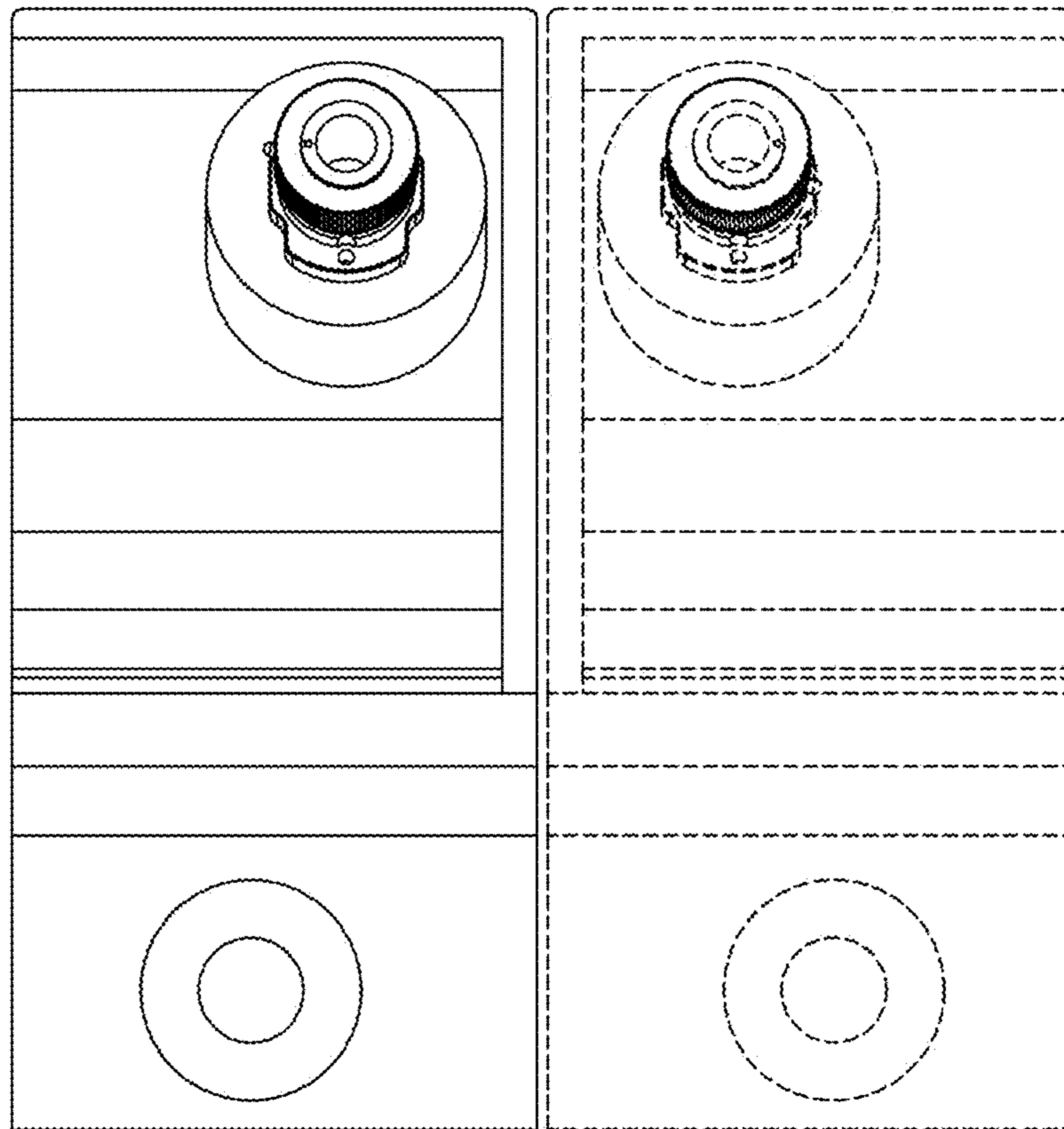


Fig. 17

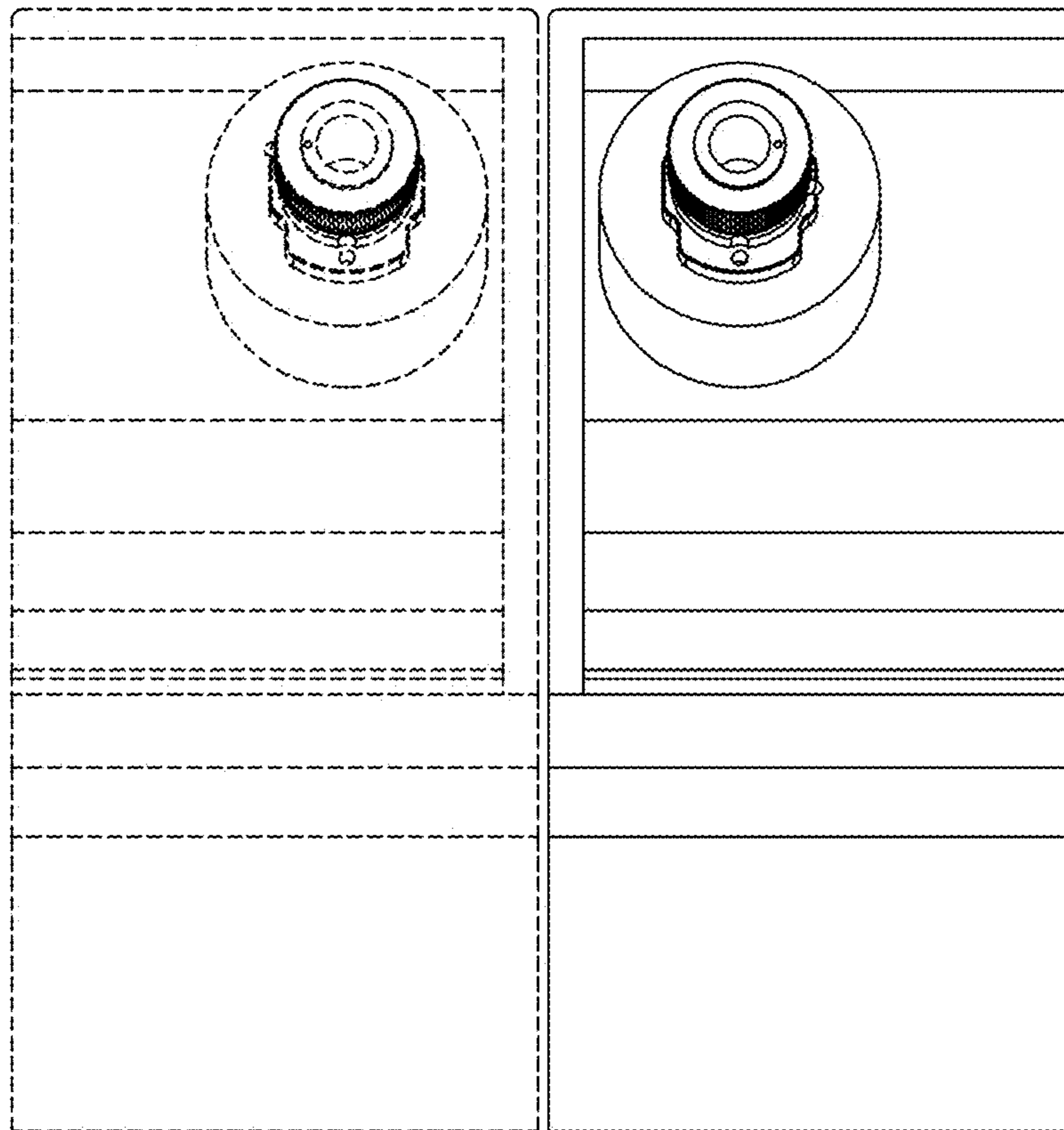


Fig. 18

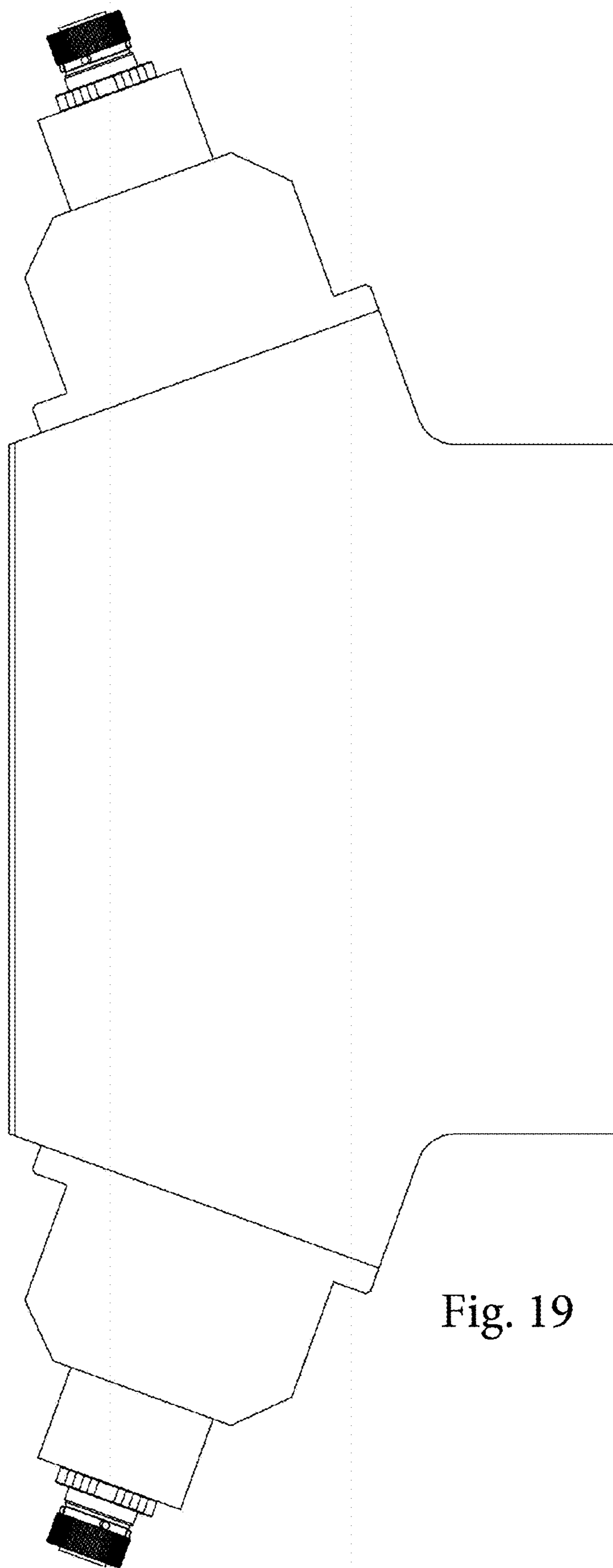


Fig. 19

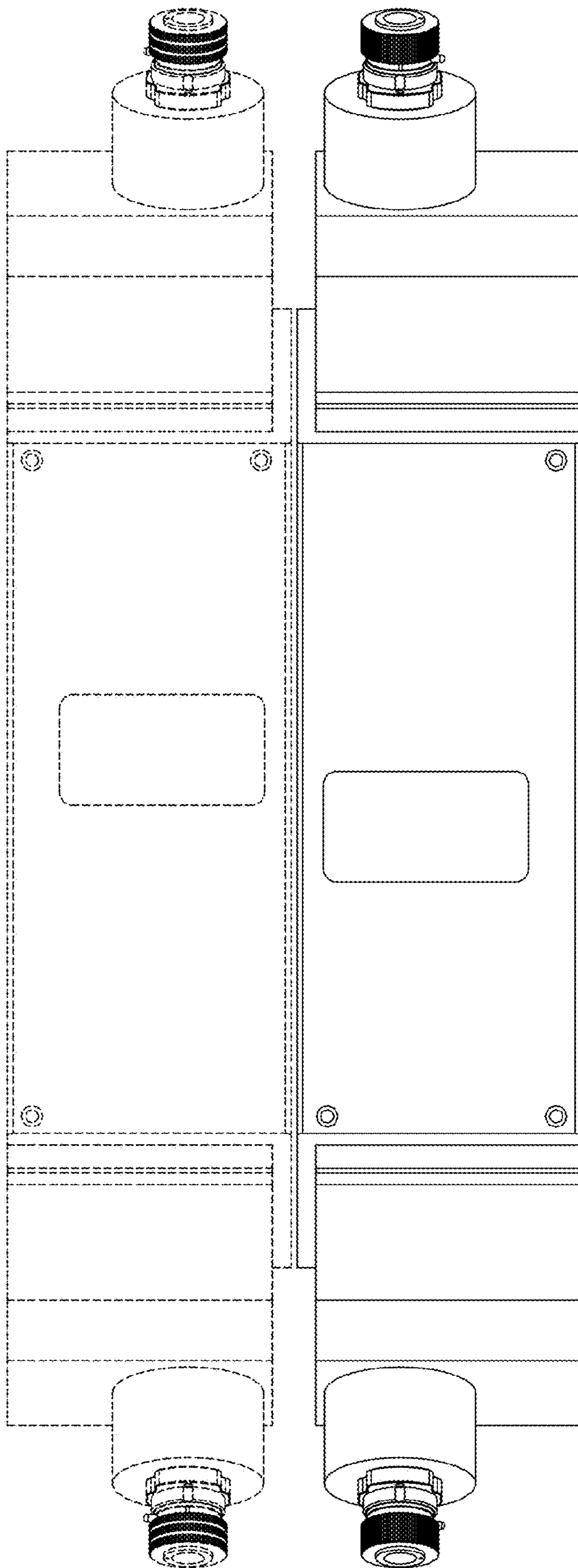


Fig. 20

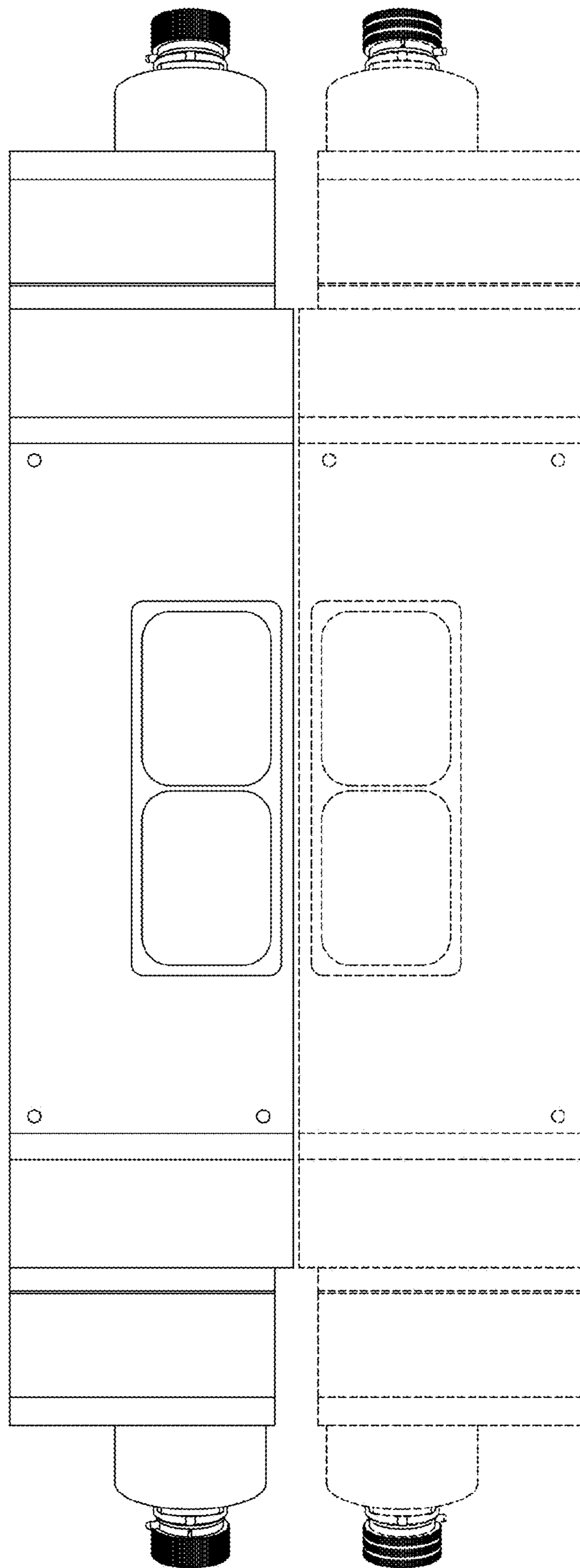


Fig. 21

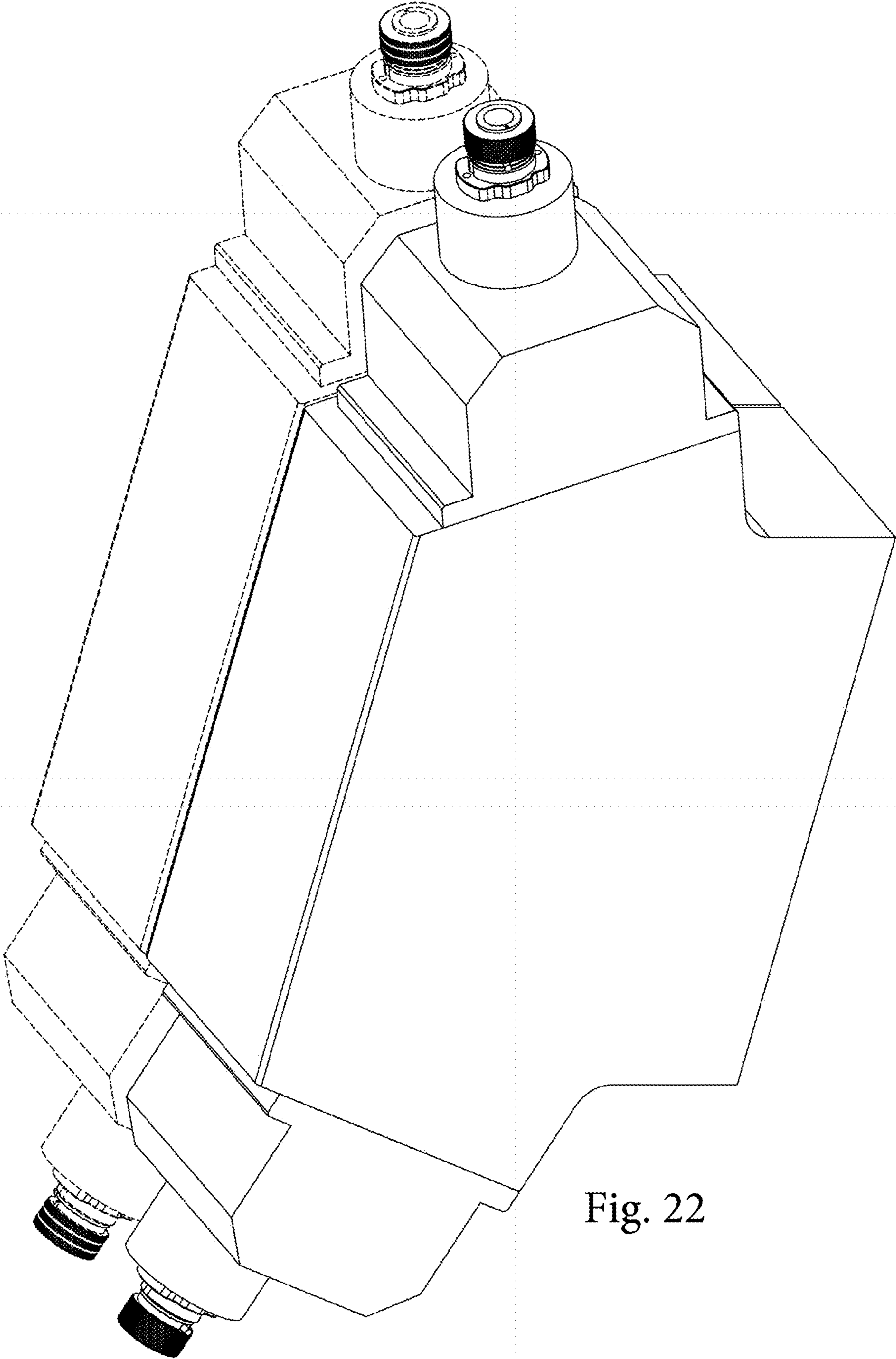


Fig. 22

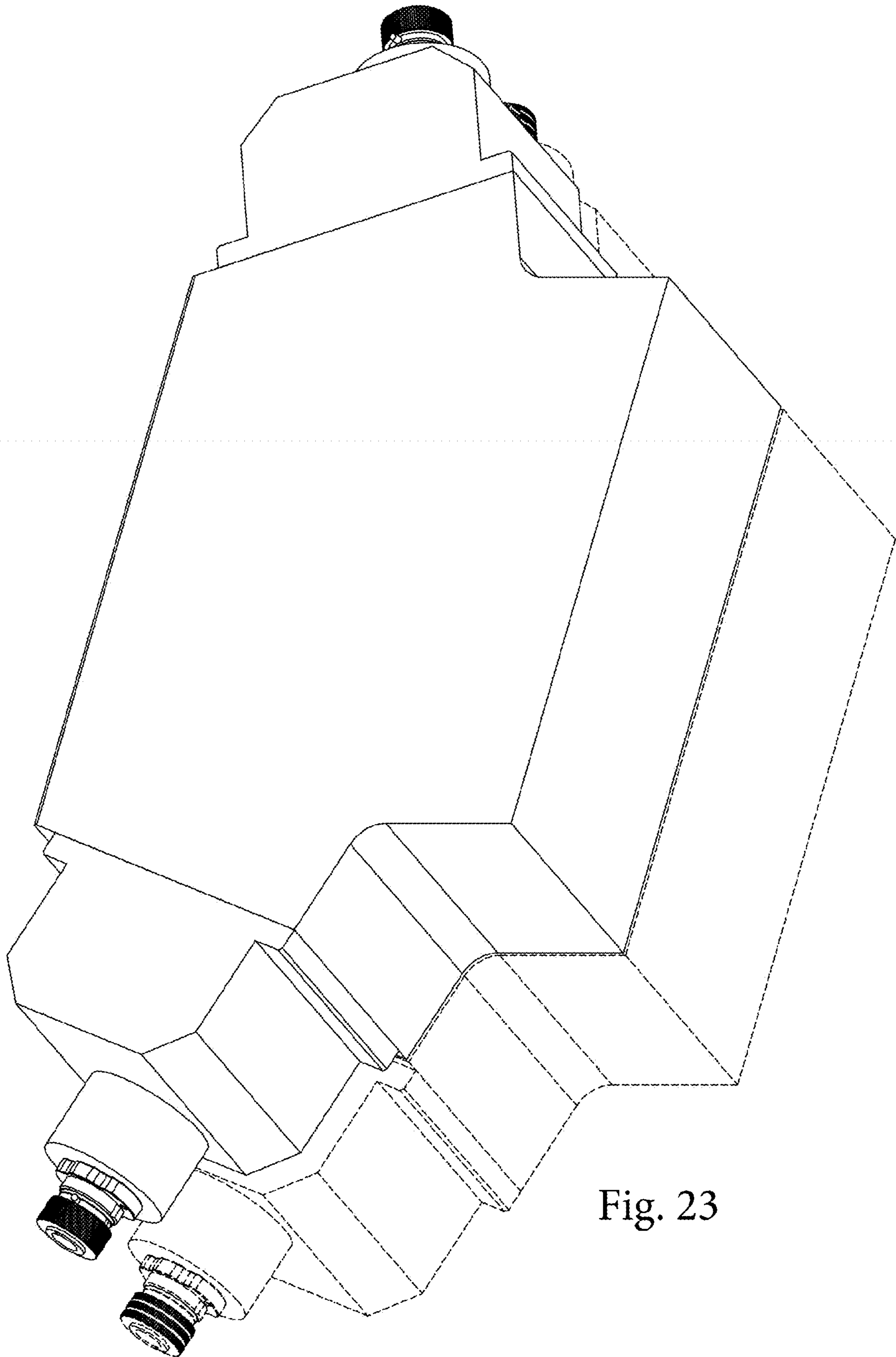


Fig. 23

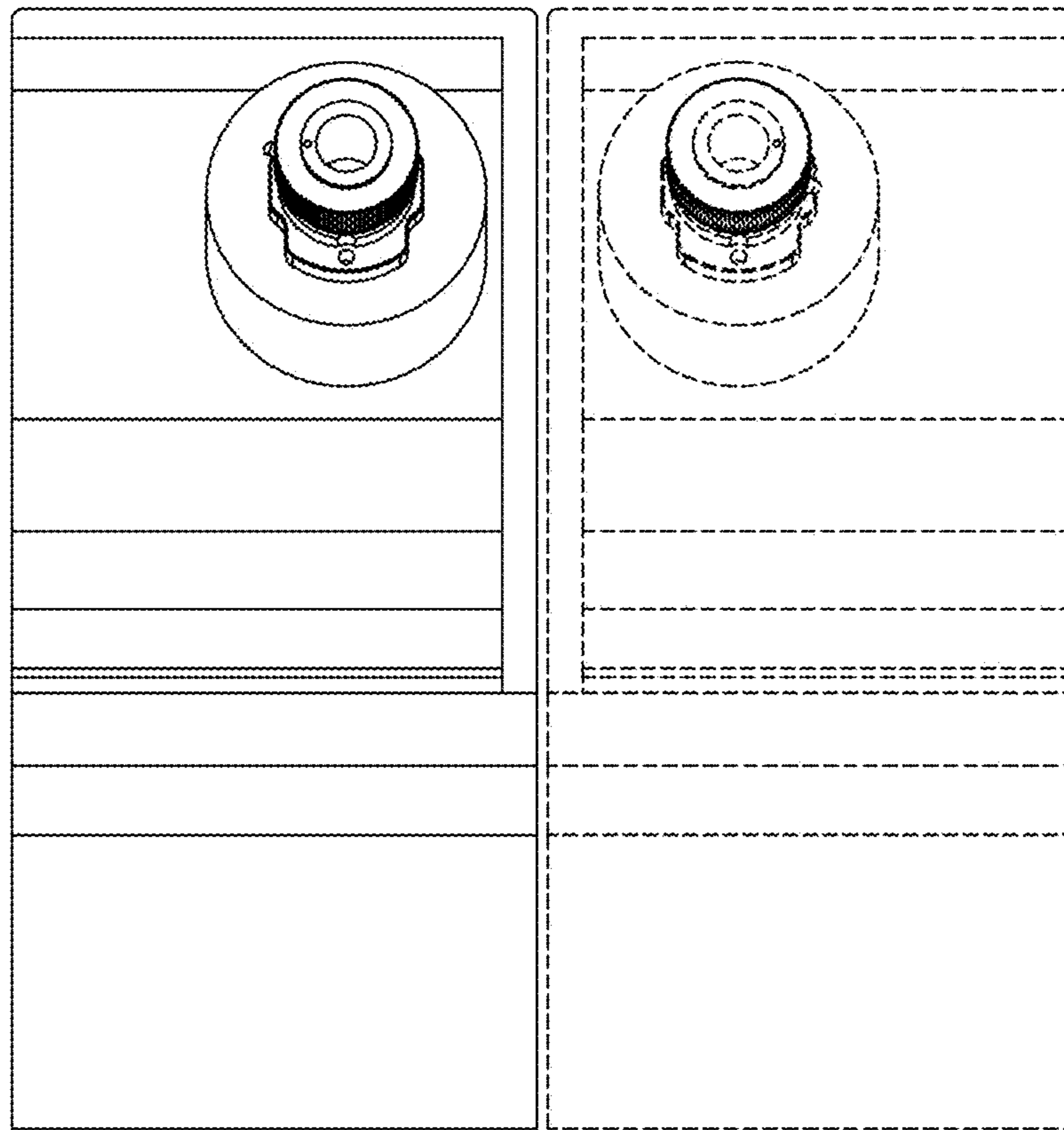


Fig. 24

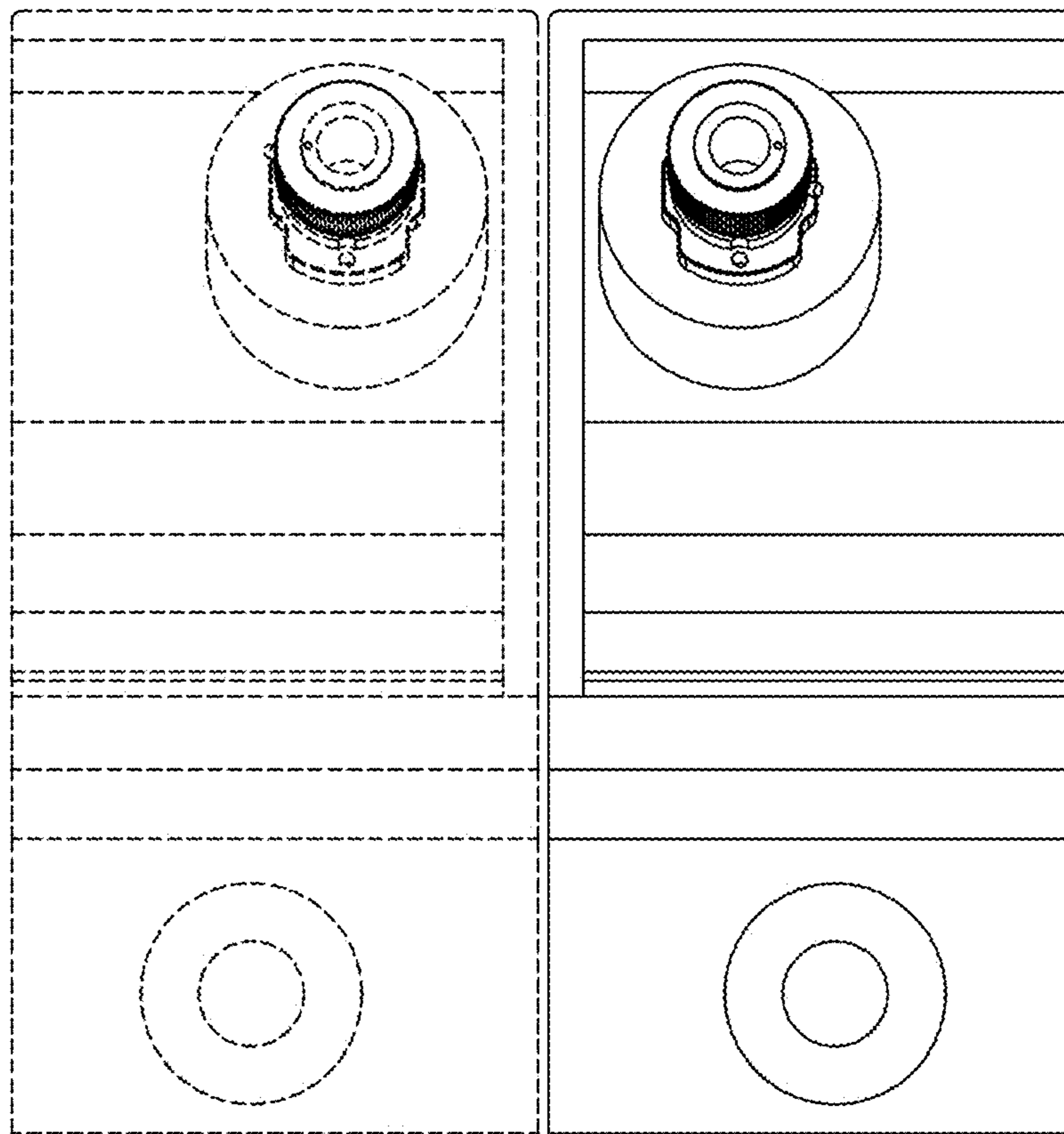


Fig. 25

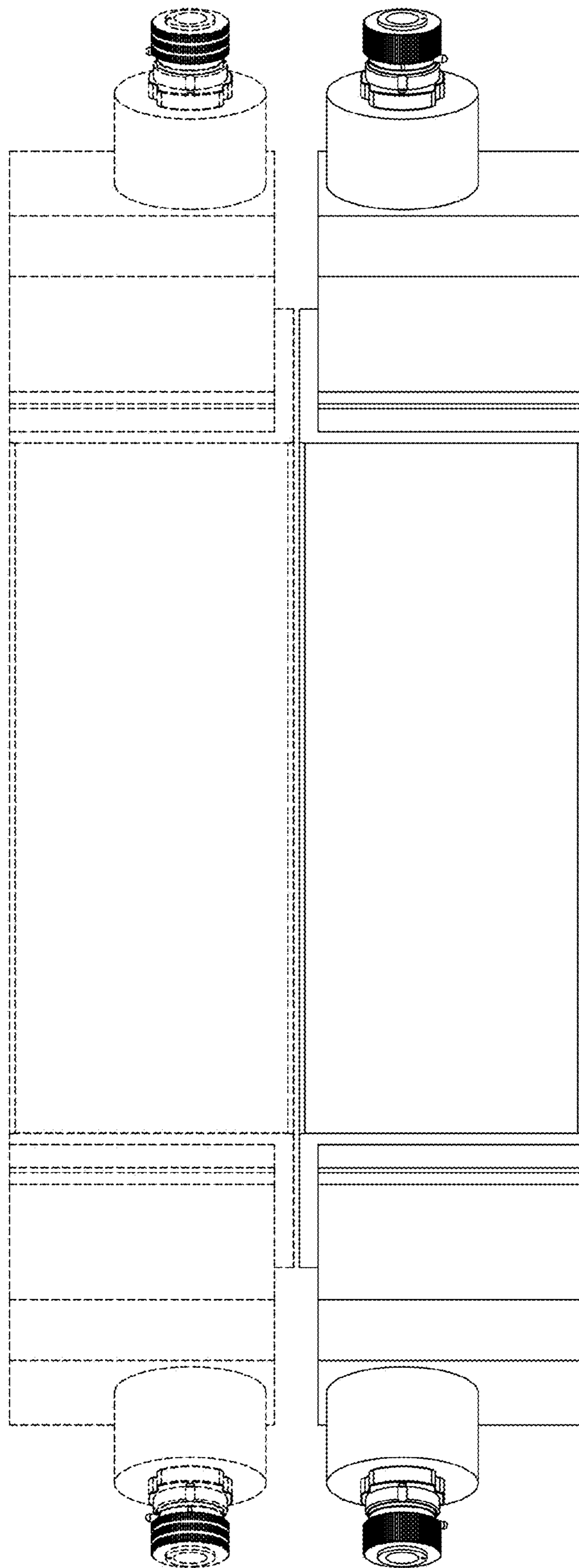


Fig. 26

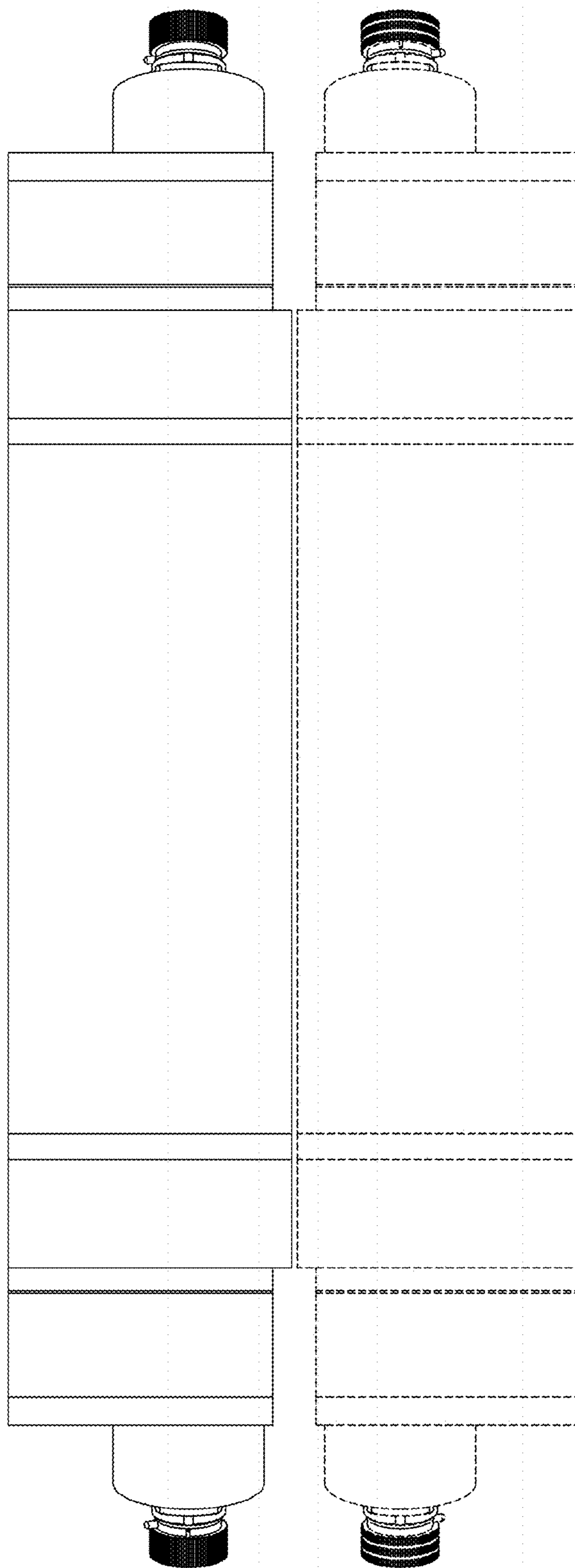


Fig. 27

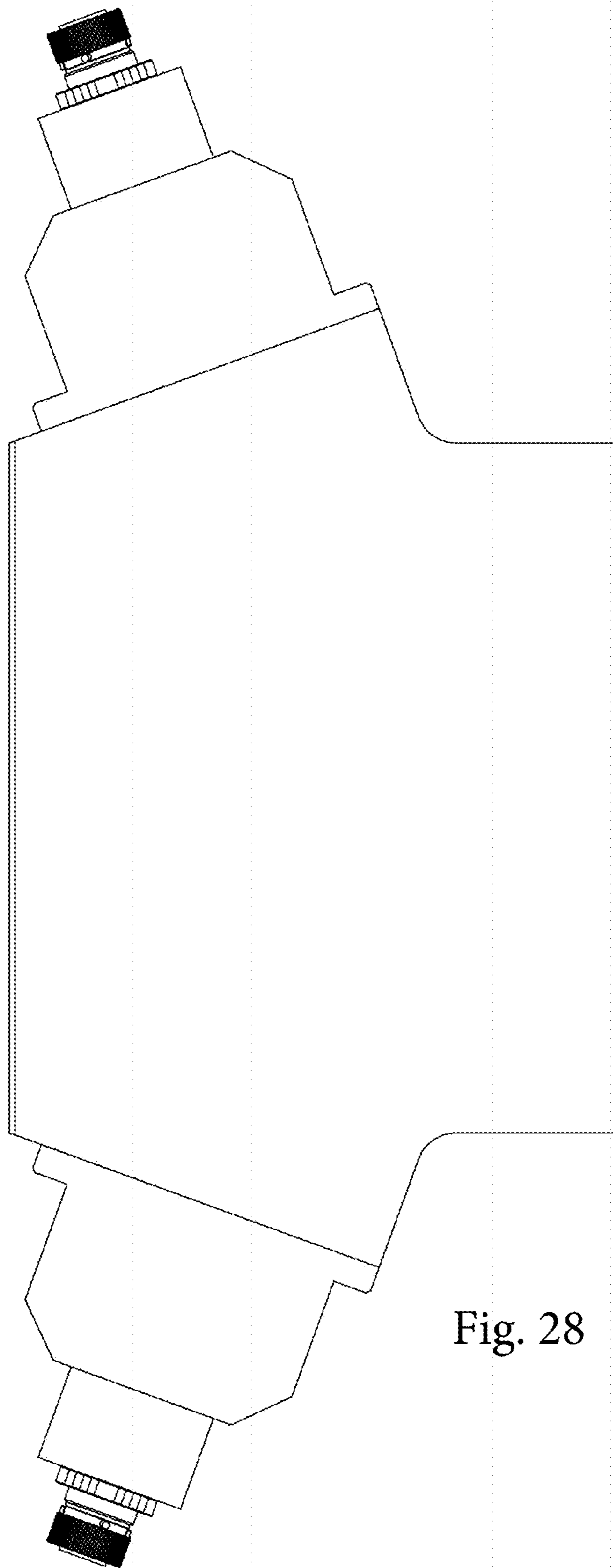


Fig. 28